

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	MAGNETIC RANDOM ACCESS MEMORY AND METHOD OF FABRICATING THEREOF						
Application Number :	10/604533						
Confirmation Number:	7-29-03						
First Named Applicant:	William Wille						
Attorney Docket Number:	FIS920020132US1						
Art Unit:	2813						
Examiner:							
Search string:	( 5695810 or 5804458 or 5920500 or 5936293 or 6147900 or 6165803 or 6351408 or 6365419 or 6381170 or 6396735 or 6048739 ).pn						
<b>US Patent Documents</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</b>							
Init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	5695810	1997-12-09	Dubin, et al.			
	2	5804458	1998-09-08	Tehrani, et al.			
	3	5920500	1999-07-06	Tehrani, et al.			
	4	5936293	1999-08-10	Parkin			
	5	6147900	2000-11-14	Pohm			
	6	6165803	2000-12-26	Chen, et al.			
	7	6351408	2002-02-26	Schwarzl, et al.			
	8	6365419	2002-04-02	Durlam, et al.			
	9	6381170	2002-04-30	Prinz			
	10	6396735	2002-05-28	Michijima, et al.			
	11	6048739	2000-04-11	Hurst, et al.			
<b>Signature</b>							
Examiner Name				Date			
				12/10/04			

<b>INFORMATION DISCLOSURE CITATION</b> <small>(Use several sheets if necessary)</small> <small>AUG 06 2003</small>				Docket Number (Optional) <b>FIS920020132US1</b>		Application Number <b>NYA</b>	
				Applicant(s) <b>NUETZEL ET AL.</b>		10/604533	
				Filing Date <b>NYA</b>		Group Art Unit <b>NYA 2813</b>	
<b>U.S. PATENT DOCUMENTS</b>							
EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<b>FOREIGN PATENT DOCUMENTS</b>							
REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
YES	NO						
<b>OTHER DOCUMENTS</b> <i>(Including Author, Title, Date, Pertinent Pages, Etc.)</i>							
	<b>1</b>	L. G. Svendsen, T. Osaka, I. Koiwa, and H. Sawai; "Chemically Deposited Ni-P and Ni-P-W Layers Investigated by Means of Rutherford Backscattering Spectrometry;" J. Electrochem. Soc.: SOLID-STATE SCIENCE AND TECHNOLOGY Vol. 130 No. 11, November 1983, pages 2255-2259					
	<b>2</b>	K. K. H. Wong, S. Kaja, P. W. DeHaven; "Metallization By Plating for High-Performance Multichip Modules," IBM Research Development, Vol. 42, No. 5, September 1998; pages 587 - 596.					
EXAMINER 				DATE CONSIDERED <b>12/11/64</b>			
<b>EXAMINER:</b> Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

INFORMATION DISCLOSURE CITATION  
(Use several sheets if necessary)

AUG 06 2003

Docket Number (Optional)	FIS920020132US1	Application Number
Applicant(s)	NUETZEL ET AL.	NYA
Filing Date	NYA	Group Art Unit NYA

\*EXAMINER  
INITIAL

PATENT &amp; TRADEMARK

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

3 L.A. D'Asaro, J. V. DiLorenzo, and H. Fukui; "Improved Performance of GaAs Microwave Field-Effect Transistors with Low Inductance Via Connections Through the Substrate;" IEEE Transactions on Electron Devices, Vol. ED-25, No. 10, October 1978; pages 1218 - 1221.

4 T. Ishikawa, K. Okaniwa, M. Komaru, K. Kosaki, and Y. Mitsui; "A High-Power GaAs FET Having Buried Plated Heat Sink for High-Performance MMIC's" IEEE Transactions on Electron Devices, Vol. 41, No. 1; January 1994; pages 3 - 9

EXAMINER

*Ex. M. H. H.*

DATE CONSIDERED

*12/11/04*

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.